TSMC Board of Directors Meeting Resolutions

HSINCHU, Taiwan, R.O.C., Nov. 10, 2026 – The TSMC (TWSE: 2330, NYSE: TSM) Board of Directors today held a meeting, which passed the following resolutions:

1. Approved the 2026 third quarter Business Report and Financial Statements. Third quarter consolidated revenue was NT$1,494.24 billion and net income was NT$763.06 billion, with diluted earnings per share of NT$29.43.

2. Approved the distribution of a NT$9.0 per share cash dividend for the third quarter of 2026, and set March 17, 2027 as the record date for common stock shareholders entitled to participate in this cash dividend distribution, and the ex-dividend date for the common shares shall be March 11, 2027. As required by Article 165 of Taiwan's Company Law, the shareholders' register shall be closed for five days prior to the record date (March 13 through March 17, 2027) for registration transfer, and the dividend will be paid on April 8, 2027. The ex-dividend date and the record date for entitlement to participate in this cash dividend distribution for TSMC American Depositary Shares (ADSs) will be March 11, 2027.

3. To meet long-term capacity plans based on market demand forecasts and TSMC's technology development roadmap, the Board approved capital appropriations of approximately US$40,926.70 million for purposes mainly including: (1) Installation and upgrade of advanced technology capacity; (2) Installation and upgrade of advanced packaging, mature and/or specialty technology capacity; (3) Fab construction, and installation of fab facility systems; (4) 2027 R&D capital investments, sustaining capital expenditures, and capitalized leased assets.

4. Approved the investment of no more than US$500 million in the establishment of an investment company for the purpose of making strategic investments in the semiconductor industry and related ecosystem.

5. Approved the investments in (1) Anthropic, PBC at its per share initial public offering price in an amount not to exceed US$500 million to acquire Anthropic's common shares; and (2) OpenAI Group PBC in an amount not to exceed US$500 million to acquire OpenAI's preferred stock.

About TSMC

TSMC pioneered the pure-play foundry business model when it was founded in 1987 and has been the world's leading dedicated semiconductor foundry ever since. The Company supports a thriving ecosystem of global customers and partners with the industry's leading process technologies and portfolio of design enablement solutions to unleash innovation for the global semiconductor industry. With global operations spanning Asia, Europe, and North America, TSMC serves as a committed corporate citizen around the world.

TSMC deployed 305 distinct process technologies, and manufactured 12,682 products for 534 customers in 2025 by providing the broadest range of advanced, specialty and advanced packaging technology services. The Company is headquartered in Hsinchu, Taiwan. For more information please visit https://www.tsmc.com.

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